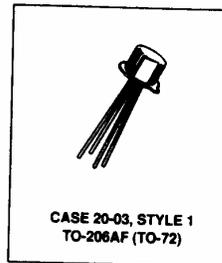


SEMICONDUCTOR
TECHNICAL DATA

2N4416A

**N-Channel, Small-Signal
Field Effect Transistor**

MAXIMUM RATINGS			
Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	35	Vdc
Drain-Gate Voltage	V _{DG}	35	Vdc
Gate-Source Voltage	V _{GS}	-35	Vdc
Gate Current	I _C	10	mAdc
Storage Temperature Range	T _{stg}	-65 to +200	°C
Power Dissipation @ T _A = 25°C Derate above 25°C	P _T	300 1.7	mW mW/°C



ELECTRICAL CHARACTERISTICS (T _A = 25°C unless otherwise noted.)				
Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Gate-Source Breakdown Voltage (I _G = 1.0 μAdc, V _{DS} = 0)	V _{(BR)GSS}	35	—	Vdc
Gate Reverse Current (V _{GS} = -20 Vdc, V _{DS} = 0) (V _{GS} = -20 Vdc, V _{DS} = 0, T _A = 150°C)	I _{GSS}	—	-0.1 -0.1	nAdc μAdc
Gate Source Cutoff Voltage (I _D = 1.0 nAdc, V _{DS} = 15 Vdc)	V _{GS(off)}	-2.5	-6.0	Vdc
Gate Source Voltage (I _D = 0.5 mAdc, V _{DS} = 15 Vdc)	V _{GS}	-1.0	-5.5	Vdc
Gate-Source Forward Voltage (I _G = 1.0 mAdc, V _{DS} = 0)	V _{GSF}	—	1.0	Vdc

(continued)

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ELECTRICAL CHARACTERISTICS — continued (T _A = 25°C unless otherwise noted.)				
Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS				
Zero-Gate Voltage Drain Current ⁽¹⁾ (V _{DS} = 15 Vdc, V _{GS} = 0)	I _{DSS}	5.0	15	mAdc
SMALL-SIGNAL CHARACTERISTICS				
Forward Transfer Admittance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 kHz, PW = 100 ms, DC = 10%) (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 kHz, T _A = -55°C)	h _{fe}	4.5 —	7.5 11.25	mmhos
Output Admittance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 kHz, PW = 100 μA, DC = 10%)	Y _{oe}	—	0.05	μs
Input Capacitance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 MHz)	C _{iss}	—	4.0	pF
Reverse Transfer Capacitance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 0.1 to 1.0 MHz)	C _{rss}	—	0.8	pF
Common-Source Output Capacitance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 0.1 to 1.0 MHz)	C _{oss}	—	2.0	pF
Common-Source Input Susceptance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 100 MHz) (V _{DS} = 15 Vdc, V _{GS} = 0, f = 400 MHz)	b _{is}	— —	2.5 10	mA
Common-Source Output Susceptance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 100 MHz) (V _{DS} = 15 Vdc, V _{GS} = 0, f = 400 MHz)	b _{oe}	— —	1.0 4.0	mA
Common-Source Input Conductance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 100 MHz) (V _{DS} = 15 Vdc, V _{GS} = 0, f = 400 MHz)	g _{is}	— —	0.3 3.0	mA
Common-Source Output Conductance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 100 MHz) (V _{DS} = 15 Vdc, V _{GS} = 0, f = 400 MHz)	g _{oe}	— —	0.075 0.4	mA
Common-Source Forward Transfer Conductance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 400 MHz)	g _{fs}	4.0	—	mA
FUNCTIONAL CHARACTERISTICS (See Figure 6)				
Noise Figure (V _{DS} = 15 Vdc, I _D = 5.0 mAdc, R _G = 1.0 kohm, f = 100 MHz) (V _{DS} = 15 Vdc, I _D = 5.0 mAdc, R _G = 1.0 kohm, f = 400 MHz)	NF	— —	2.0 4.0	dB
Common-Source Insertion Power Gain (V _{DS} = 15 Vdc, I _D = 5.0 mAdc, R _G = 1.0 kohm, f = 100 MHz) (V _{DS} = 15 Vdc, I _D = 5.0 mAdc, R _G = 1.0 kohm, f = 400 MHz)	G _{pe}	18 10	— —	dB

ASSURANCE TESTING (Pre/Post Burn-In)				
Burn-In Conditions: T _A = 175°C, V _{GS} = -24 Vdc, V _{DS} = 0				
Characteristics Tested	Symbol	Initial and End Point Limits		Unit
		Min	Max	
Gate Reverse Current (V _{GS} = -20 Vdc)	I _{GSS}	—	0.1	nAdc
Zero-Gate Voltage Drain Current ⁽¹⁾ (V _{DS} = 15 Vdc, V _{GS} = 0)	I _{DSS}	5.0	15	mAdc
Forward Transfer Admittance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 kHz)	Y _{fa}	4.5	7.5	mmho

Delta from Pre-Burn-In Measured Values		Min	Max	
Delta Forward Transfer Admittance	Δ Y _{fa}	—	±20	% of Initial Value
Delta Zero-Gate Voltage Drain Current ⁽¹⁾	ΔI _{DSS}	—	±10	% of Initial Value

(1) Pulsed Pulse Width 250 to 350 us. Duty Cycle 1.0 to 2.0%

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